SamHop Microelectronics Corp.

STS3420

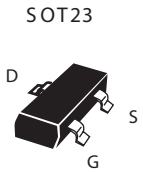
Ver 1.1

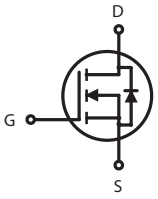
N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ) Max
30V	4.5A	33 @ VGS= 10V
		40 @ VGS= 4.5V
		53 @ VGS= 2.5V

FEATURES

- Super high dense cell design for low $R_{DS(ON)}$.
- Rugged and reliable.
- Suface Mount Package.





ABSOLUTE MAXIMUM RATINGS (T_A=25°C unless otherwise noted)

Symbol	Parameter		Limit	Units
V_{DS}	Drain-Source Voltage		30	V
V_{GS}	Gate-Source Voltage		±12	V
I_D	Drain Current-Continuous [a]	T_C=25°C	4.5	A
		T_C=70°C	3.6	A
I_{DM}	-Pulsed [b]		18	A
P_D	Maximum Power Dissipation [a]	T_C=25°C	1.25	W
		T_C=70°C	0.8	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range		-55 to 150	°C

THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient [a]	100	°C/W

ELECTRICAL CHARACTERISTICS (T_A=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V , I_D=250uA	30			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=24V , V_{GS}=0V			1	uA
I_{GSS}	Gate-Body Leakage Current	V_{GS}= ±12V , V_{DS}=0V			±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS} , I_D=250uA	0.5	0.78	1.5	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=10V , I_D=2.3A		26	33	m ohm
		V_{GS}=4.5V , I_D=2A		30	40	m ohm
		V_{GS}=2.5V , I_D=1.8A		39	53	m ohm
g_{FS}	Forward Transconductance	V_{DS}=5V , I_D=2.3A		13		S
DYNAMIC CHARACTERISTICS [c]						
C_{ISS}	Input Capacitance	V_{DS}=15V,V_{GS}=0V f=1.0MHz		430		pF
C_{OSS}	Output Capacitance			68		pF
C_{RSS}	Reverse Transfer Capacitance			55		pF
SWITCHING CHARACTERISTICS [c]						
$t_{D(ON)}$	Turn-On Delay Time	V_{DD}=15V I_D=1A V_{GS}=10V R_{GEN}= 6 ohm		5.6		ns
t_r	Rise Time			8		ns
$t_{D(OFF)}$	Turn-Off Delay Time			17.5		ns
t_f	Fall Time			25		ns
Q_g	Total Gate Charge	V_{DS}=15V,I_D=2.3A,V_{GS}=10V		8.1		nC
		V_{DS}=15V,I_D=2.3A,V_{GS}=4.5V		4.5		nC
Q_{gs}	Gate-Source Charge	V_{DS}=15V,I_D=2.3A, V_{GS}=10V		0.8		nC
Q_{gd}	Gate-Drain Charge			1.7		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
V_{SD}	Diode Forward Voltage	V_{GS}=0V,I_S= 1A		0.77	1.2	V

Notes

a.Surface Mounted on FR4 Board,t ≤ 10sec.
b.Pulse Test:Pulse Width ≤ 300us, Duty Cycle ≤ 2%.
c.Guaranteed by design, not subject to production testing.

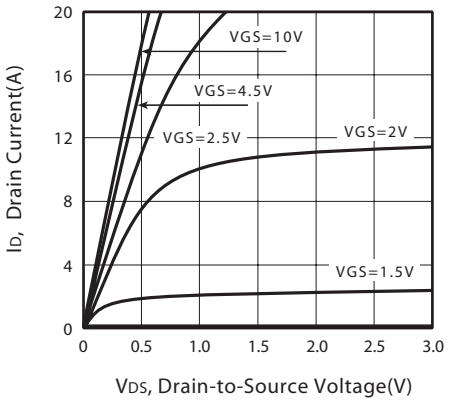


Figure 1. Output Characteristics

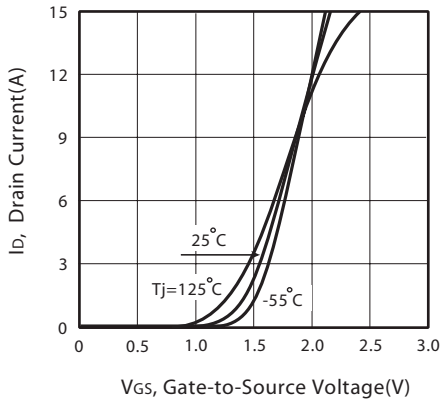


Figure 2. Transfer Characteristics

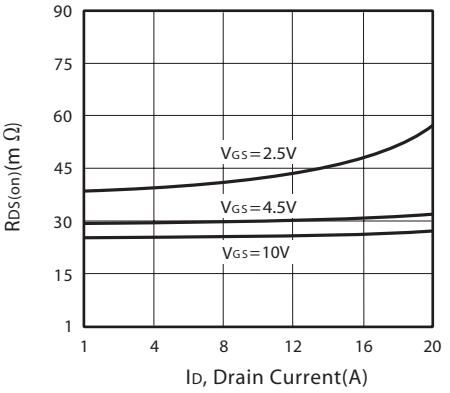


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

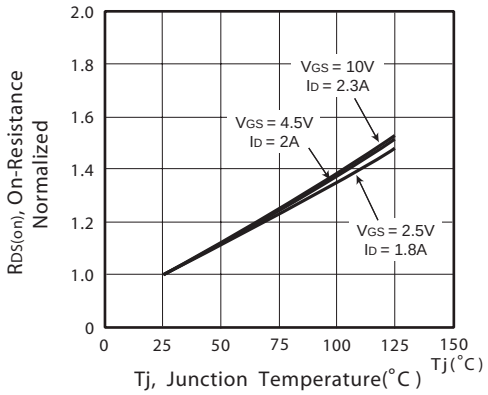


Figure 4. On-Resistance Variation with Drain Current and Temperature

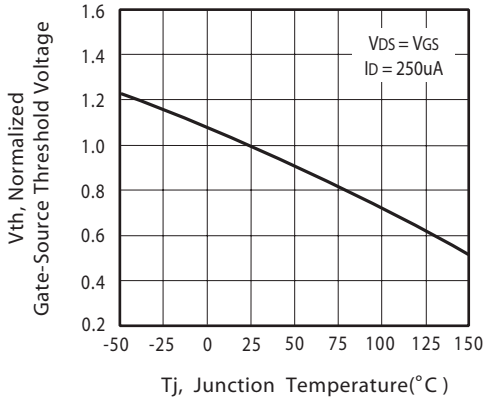


Figure 5. Gate Threshold Variation with Temperature

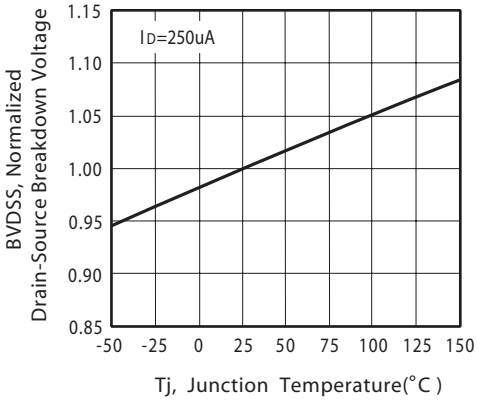


Figure 6. Breakdown Voltage Variation with Temperature

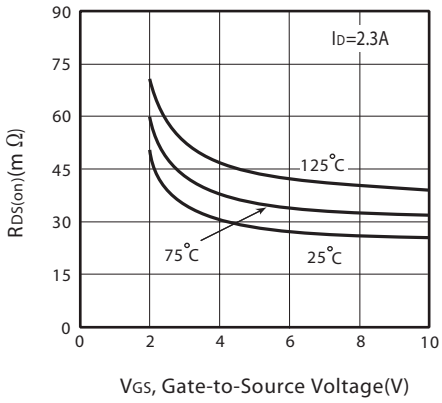


Figure 7. On-Resistance vs. Gate-Source Voltage

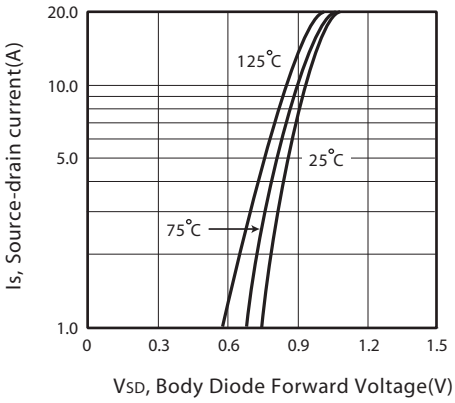


Figure 8. Body Diode Forward Voltage Variation with Source Current

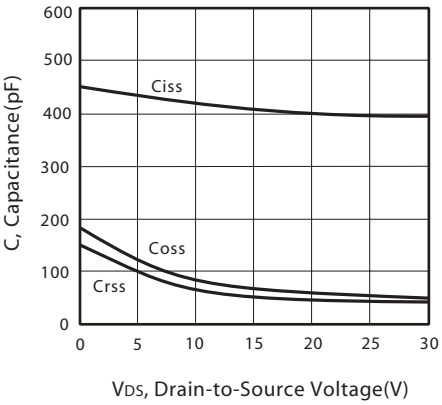


Figure 9. Capacitance

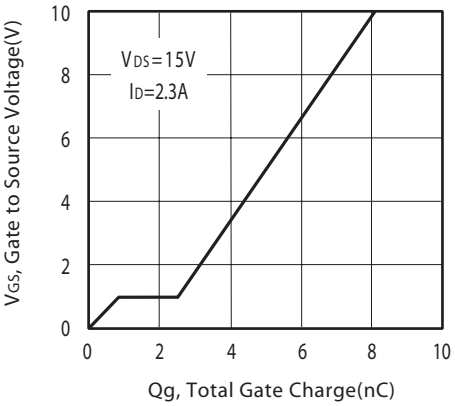


Figure 10. Gate Charge

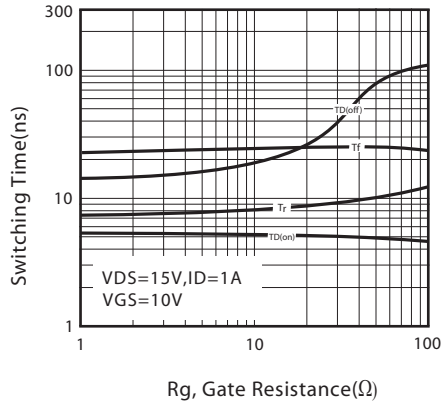


Figure 11. switching characteristics

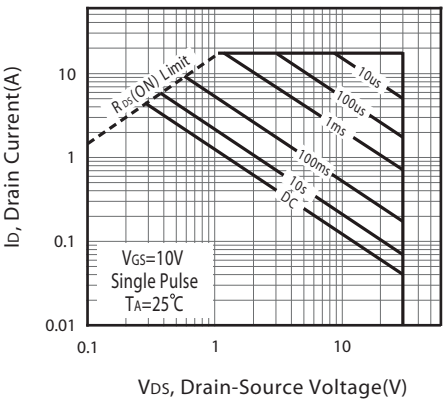


Figure 12. Maximum Safe Operating Area

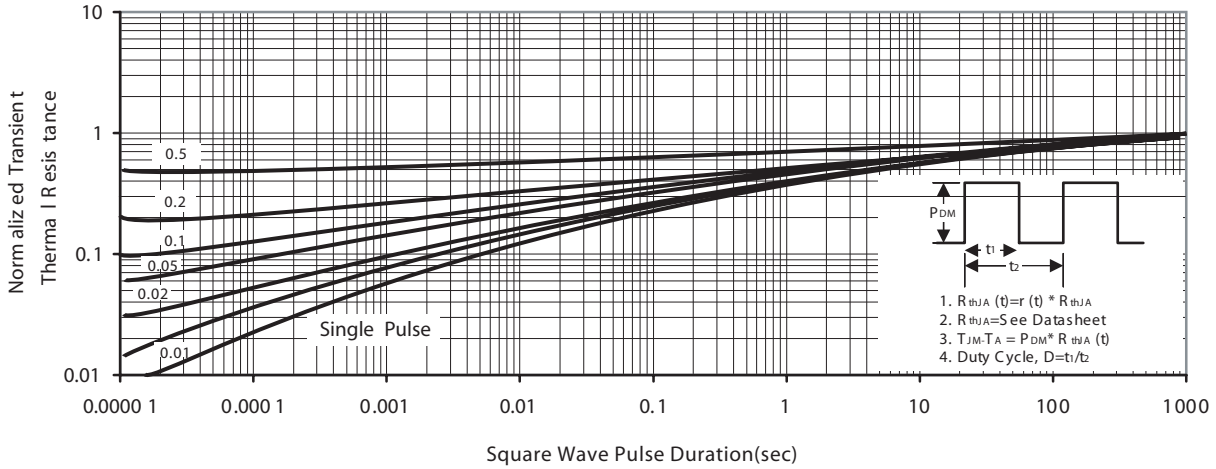
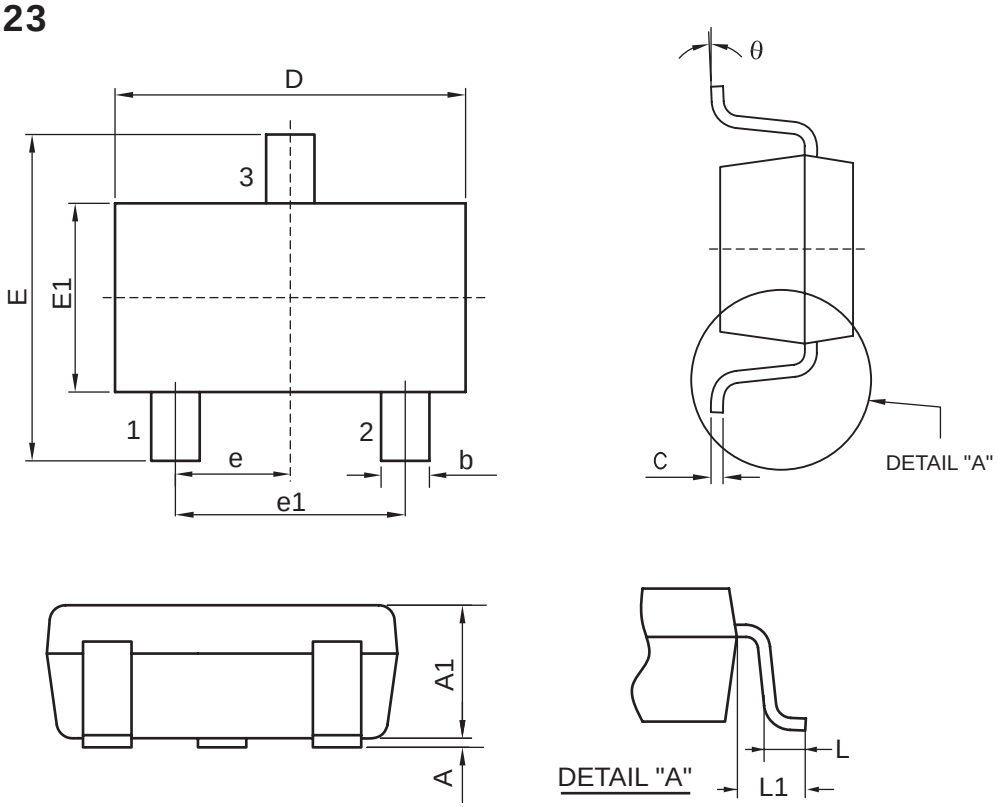


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

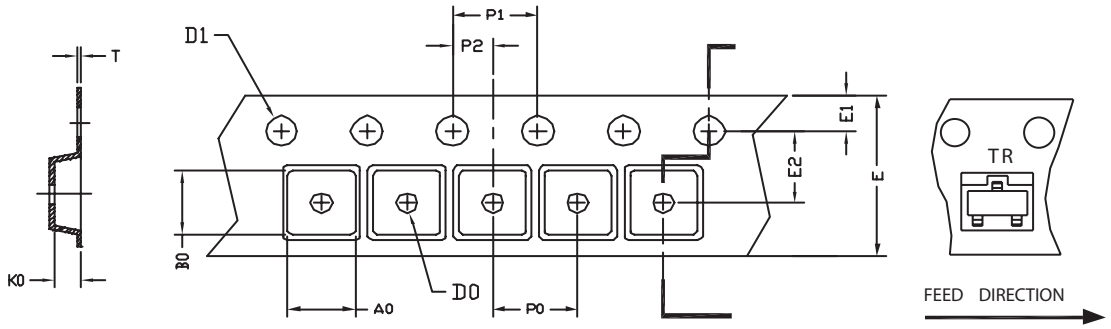
SOT 23



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
D	2.700	3.100	0.106	0.122
E	2.200	3.000	0.087	0.118
E1	1.200	1.700	0.047	0.067
e	0.850	1.150	0.033	0.045
e1	1.800	2.100	0.071	0.083
b	0.350	0.510	0.014	0.020
C	0.090	0.200	0.004	0.008
A	0.000	0.102	0.000	0.004
A1	0.887	1.200	0.035	0.047
L	0.450 REF.		0.018 REF.	
L1	0.550 REF.		0.022 REF.	
θ	0°	10°	0°	10°

SOT-23 Tape and Reel Data

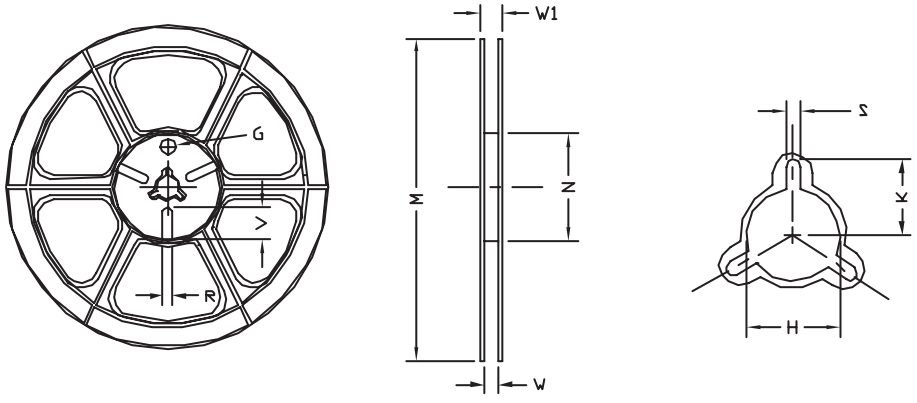
SOT-23 Carrier Tape



UNIT:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOT-23	3.20 ±0.10	3.00 ±0.10	1.33 ±0.10	ϕ1.00 +0.25	ϕ1.50 +0.10	8.00 +0.30 -0.10	1.75 ±0.10	3.50 ±0.05	4.00 ±0.10	4.00 ±0.10	2.00 ±0.05	0.20 ±0.02

SOT-23 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
8mm	ϕ178	ϕ178 ±1	ϕ60 ±1	9.00 ±0.5	12.00 ±0.5	ϕ13.5 ±0.5	10.5	2.00 ±0.5	ϕ10.0	5.00	18.00

TOP MARKING DEFINITION

SOT-23